

N-Channel Enhancement-Mode Vertical DMOS FETs

Ordering Information

BV _{DSS} /	R _{DS(ON)} V _{GS(th)} I _{D(ON)}			Order Number / Package			
BV _{DGS}	(max) (max) (min)		TO-92	TO-243AA*	Die [†]		
400V	12Ω	2.0V	1.0A	TN2540N3	TN2540N8	TN2540ND	

* Same as SOT-89. Product supplied on 2000 piece carrier tape reels.

[†] MIL visual screening available.

Features

- □ Low threshold 2.0V max.
- □ High input impedance
- □ Low input capacitance 125pF max.
- □ Fast switching speeds
- Low on resistance
- □ Free from secondary breakdown
- Low input and output leakage
- □ Complementary N- and P-channel devices

Applications

- □ Logic level interfaces ideal for TTL and CMOS
- Solid state relays
- Battery operated systems
- Photo voltaic drives
- Analog switches
- General purpose line drivers
- Telecom switches

Absolute Maximum Ratings

Drain-to-Source Voltage	BV_{DSS}
Drain-to-Gate Voltage	BV _{DGS}
Gate-to-Source Voltage	± 20V
Operating and Storage Temperature	-55°C to +150°C
Soldering Temperature*	300°C
*	

* Distance of 1.6 mm from case for 10 seconds.

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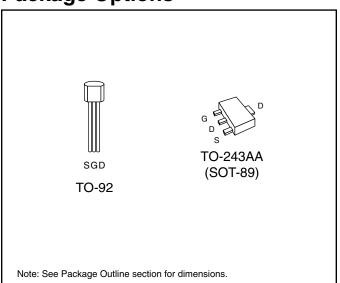


Product marking for TO-243AA

These low threshold enhancement-mode (normally-off) transistors utilize a vertical DMOS structure and Supertex's well-proven silicon-gate manufacturing process. This combination produces devices with the power handling capabilities of bipolar transistors and with the high input impedance and positive temperature coefficient inherent in MOS devices. Characteristic of all MOS structures, these devices are free from thermal runaway and thermally induced secondary breakdown.

Supertex's vertical DMOS FETs are ideally suited to a wide range of switching and amplifying applications where very low threshold voltage, high breakdown voltage, high input impedance, low input capacitance, and fast switching speeds are desired.

Package Options



Supertex Inc. does not recommend the use of its products in life support applications and will not knowingly sell its products for use in such applications unless it receives an adequate "products liability indemnification insurance agreement." Supertex does not assume responsibility for use of devices described and limits its liability to the replacement of devices determined to be defective due to workmanship. No responsibility is assumed for possible omissions or inaccuracies. Circuitry and specifications are subject to change without notice. For the latest product specifications, refer to the Supertex website: http://www.supertex.com. For complete liability information on all Supertex products, refer to the most current databook or to the Legal/Disclaimer page on the Supertex website.

Thermal Characteristics

Package	I _D (continuous)*	I _D (pulsed)	Power Dissipation @ T _A = 25°C	θ _{jc} °C/W	θ _{ja} °C/W	I _{DR} *	I _{DRM}
TO-92	175mA	2.0A	1.0W	125	170	175mA	2.0A
TO-243AA	260mA	1.8A	1.6W [†]	15	78†	260mA	1.8A

 * I_D (continuous) is limited by max rated T_j. † Mounted on FR5 board, 25mm x 25mm x 1.57mm. Significant P_D increase possible on ceramic substrate.

Electrical Characteristics (@ 25°C unless otherwise specified)

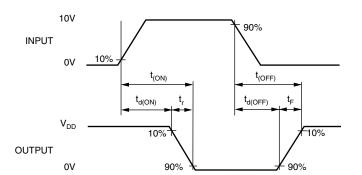
Symbol	Parameter	Min	Тур	Мах	Unit	Conditions	
BV_{DSS}	Drain-to-Source Breakdown Voltage	400			V	$V_{GS}=0V,I_{D}=100\mu A$	
V _{GS(th)}	Gate Threshold Voltage	0.6		2.0	V	$V_{GS} = V_{DS}, I_{D} = 1mA$	
$\Delta V_{GS(th)}$	Change in $V_{GS(th)}$ with Temperature		-2.5	-4.0	mV/°C	$V_{GS} = V_{DS}, I_{D} = 1mA$	
I _{GSS}	Gate Body Leakage			100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
I _{DSS}	Zero Gate Voltage Drain Current			10	μA	$V_{GS} = 0V, V_{DS} = Max Rating$	
				1.0	mA	$V_{GS} = 0V$, $V_{DS} = 0.8$ Max Rating $T_A = 125^{\circ}C$	
I _{D(ON)}	ON-State Drain Current	0.3	0.5		A	$V_{GS} = 4.5V, V_{DS} = 25V$	
		0.75	1.0			$V_{GS} = 10V, V_{DS} = 25V$	
R _{DS(ON)} Sta	Static Drain-to-Source ON-State Resistance		8.0	12	Ω	$V_{GS} = 4.5V, I_{D} = 150mA$	
			8.0	12		$V_{GS} = 10V, I_{D} = 500mA$	
$\Delta R_{DS(ON)}$	Change in R _{DS(ON)} with Temperature			0.75	%/°C	$V_{GS} = 10V, I_{D} = 500mA$	
G _{FS}	Forward Transconductance	125	200		mប	$V_{DS} = 25V, I_{D} = 100mA$	
C _{ISS}	Input Capacitance		95	125		$V_{GS} = 0V, V_{DS} = 25V$ f = 1 MHz	
C _{OSS}	Common Source Output Capacitance		20	70	pF		
C _{RSS}	Reverse Transfer Capacitance		10	25			
t _{d(ON)}	Turn-ON Delay Time			20			
t _r	Rise Time			15	- ns	$V_{DD} = 25V,$ $I_D = 1A,$ $R_{GEN} = 25\Omega$	
t _{d(OFF)}	Turn-OFF Delay Time			25			
t _f	Fall Time			20			
V _{SD}	Diode Forward Voltage Drop			1.8	V	$V_{GS} = 0V, I_{SD} = 200mA$	
t _{rr}	Reverse Recovery Time		300		ns	$V_{GS} = 0V, I_{SD} = 1A$	

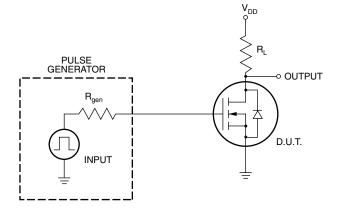
Notes:

1. All D.C. parameters 100% tested at 25°C unless otherwise stated. (Pulse test: 300 us pulse, 2% duty cycle.)

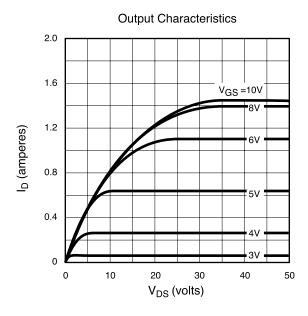
2. All A.C. parameters sample tested.

Switching Waveforms and Test Circuit

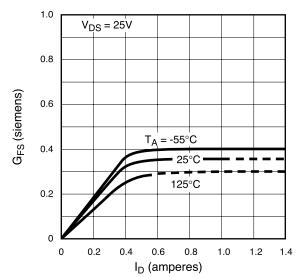




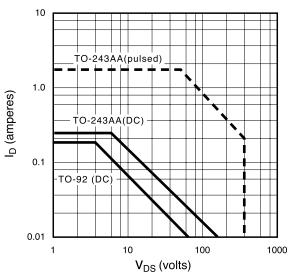
Typical Performance Curves

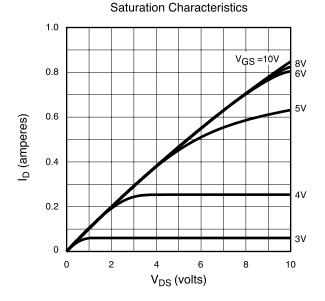


Transconductance vs. Drain Current

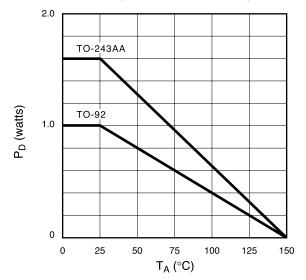


Maximum Rated Safe Operating Area

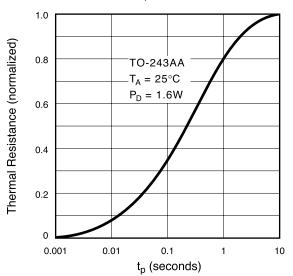




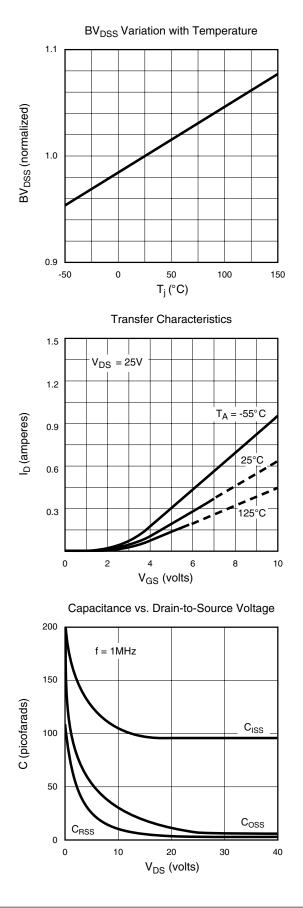
Power Dissipation vs. Ambient Temperature



Thermal Response Characteristics

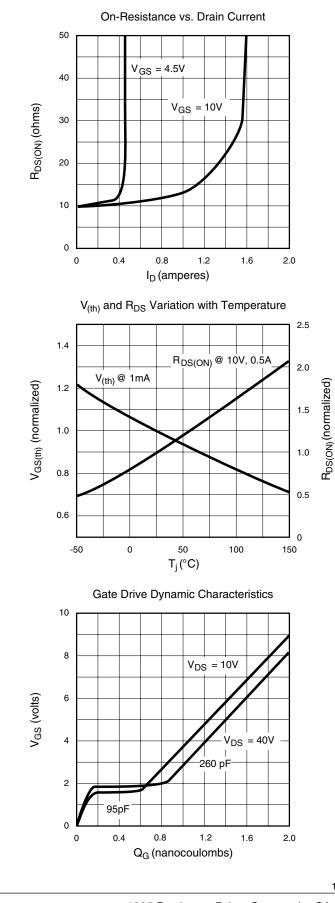


Typical Performance Curves





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